



INTERFLUX[®] PACIFIC 2009

"No-Residue" flux

DESCRIPTION

The Interflux[®] PACIFIC 2009 is an environmental friendly flux especially developed without any presence of volatile organic compounds. The flux contains no halides, neither rosin nor resin components.

It can be used till the last drop, it will give excellent soldering results and no contact problems.

PACIFIC 2009 has very good wetting capacity and is suitable for soldering with normal 63/37, lead-free alloys and for components and PCB-finishes with critical solderability.

PHYSICAL AND CHEMICAL PROPERTIES

# Density at 20°C	: 1.00 g/ml ±0.01
# Colour	: colourless
# Odour	: sweet smell
# Solids content % w/w	: 2.5 % ±0.15
# Halide content	: 0 %
# Flash point (T.O.C.)	: none
# Total Acid Number	: 16 mg KOH/g ±2

APPLICATIONS

This flux is suitable for use with spraying techniques.

All water should be evaporated before the PCB reaches the solder wave.

Contact time of PCB with the solder should be between 2 and 5 seconds.

PACKAGING

10 litres and 25 litres in high density polyethylene drums.

APPROVALS AND TEST RESULTS

IPC test results included.

Because we cannot anticipate or control the many different conditions under which this information and our products may be used, we do not guarantee the applicability or the accuracy of this information or the suitability of our products in any given situation. Users of our products should make their own test to determine the suitability of each such product for their particular purposes. The product discussed is sold without such warranty, either express or implied.

Copyrights reserved to Interflux[®] Electronics NV